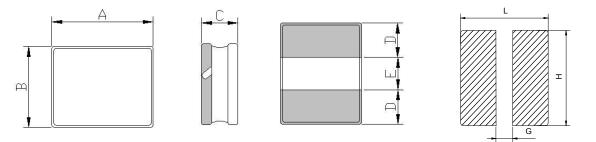
## 1. Part No. Expression:

## <u>SPA201610FA</u> <u>\_\_\_</u>M

(a) (b) (c) (d) (e)

- a) Series Code d) Inductance Code
- b) Dimension Code e) Tolerance Code
- c) Type Code

# 2. Configuration & Dimensions:



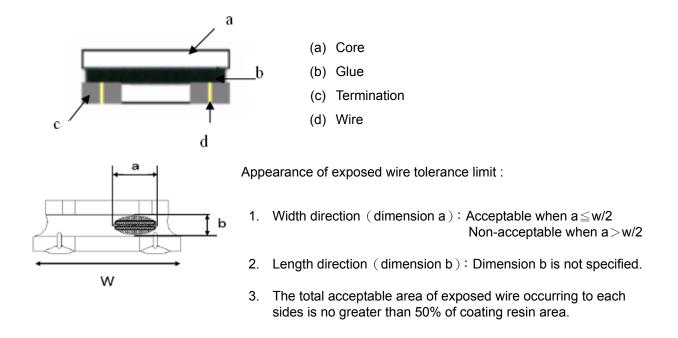
Recommended PC Board Pattern

Unit: mm

А	В	С	D	E	L	G	Н
2.0 +0.2/-0.1	1.6 +0.2/-0.1	1.0 Max.	0.5 Ref.	1.0 Ref.	2.3 Ref.	0.8 Ref.	1.9 Ref.



3. Material List:



## 4. General Specification:

- (a) Operating Temp. : -40°C to +125°C (including self-temperature rise)
- (b) Storage Temp. : -40°C to +125°C (on board)
- (c) Humidity Range : 85 ± 2% RH
- (d) Heat Rated Current (Irms) will cause the coil temperature rise approximately Δt of 40°C (keep 1min)
- (e) Saturation Current (Isat Typ.) will cause L0 to drop approximately 30%.
- (f) Part Temperature (Ambient+Temp. Rise) : Should not exceed 125°C under worst case operating conditions.
- (g) Storage condition (component in its packaging)

i) Temperature: Less than 40°C ii)Humidity : 60% RH

Part Number	Inductance (uH)	Tolerance (%)	Test Frequency (Hz)	DCR (Ω) Max.	l sat (A) Max.	l rms (A) Max.
SPA201610FAR24M	0.24	±20	1V/1M	0.020	6.50	5.10 (1) 5.50 (2)
SPA201610FAR33M	0.33	±20	1V/1M	0.023	5.00	5.00 (1) 5.20 (2)
SPA201610FAR47M	0.47	±20	1V/1M	0.029	4.50	4.30 (1) 4.70 (2)
SPA201610FAR68M	0.68	±20	1V/1M	0.044	4.40	3.50 (1) 3.80 (2)
SPA201610FA1R0M	1.0	±20	1V/1M	0.060	4.00	2.90 (1) 3.10 (2)
SPA201610FA1R5M	1.5	±20	1V/1M	0.082	2.80	2.50 (1) 2.70 (2)
SPA201610FA2R2M	2.2	±20	1V/1M	0.120	2.40	2.00 (1) 2.10 (2)
SPA201610FA4R7M	4.7	±20	1V/1M	0.216	1.40	1.40 (1) 1.60 (2)

## 5. Electrical Characteristics:

\*Tolerance code : M = 20%

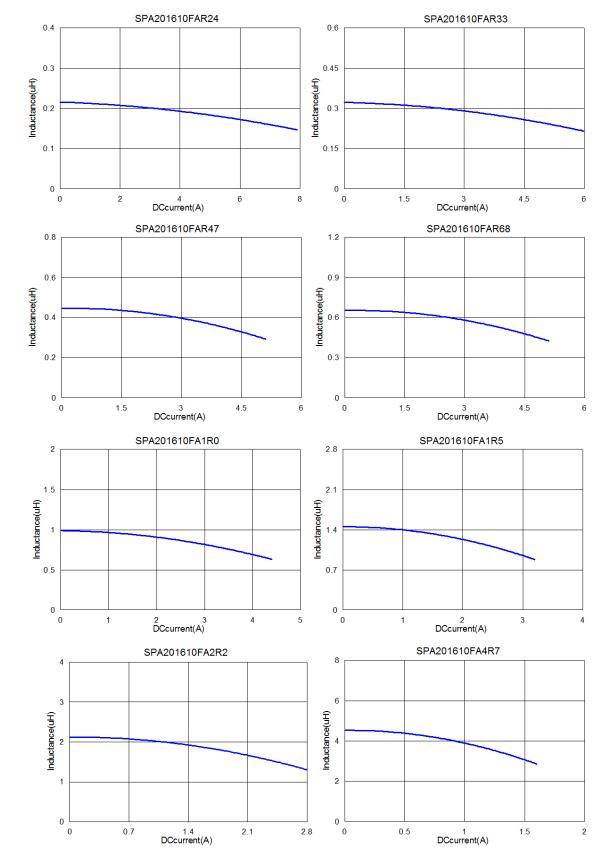
\*For Irms (A) Max. values with '(1)' or '(2)', refer to notes below for board test conditions.

Notes:

1) At all times, the current supplied to the product should not exceed Irms Max. value

2) Irms Max. board test conditions:

Irms (1) Material: FR4 Board dimensions: 100 X 50 X 1.6t mm Pattern dimensions: 45 X 30 mm (Double side board) Pattern thickness: 50 µm Irms (2) Material: FR4 Board dimensions: 100 X 50 X 1.6t mm Pattern dimensions: 45 X 45 mm (Double side board) Pattern thickness: 70 µm



## 6. Characteristics Curves:

NOTE: Specifications subject to change without notice. Please check our website for latest information.



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## 7. Soldering:

Mildly activated rosin fluxes are preferred. The minimum amount of solder can lead to damage from the stresses caused by the difference in coefficients of expansion between solder, chip and substrate. Our terminations are suitable for all re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air.

#### 8-1 Solder Re-flow:

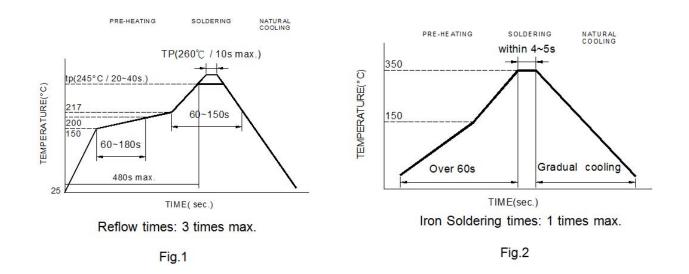
Recommended temperature profiles for re-flow soldering in Figure 1.

#### 8-2 Soldering Iron (Figure 2):

Products attachment with soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended.

Note :

- a) Preheat circuit and products to 150°C.
- b) 355°C tip temperature (Max.)
- c) Never contact the ceramic with the iron tip
- d) 1.0mm tip diameter (Max.)
- e) Use a 20 watt soldering iron with tip diameter of 1.0mm
- f) Limit soldering time to 4~5 secs.

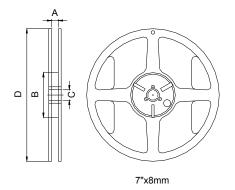


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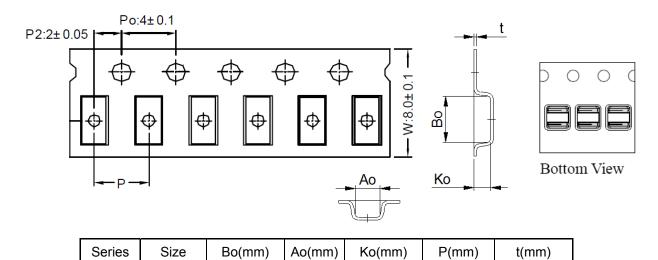
## 8. Packaging Information:

### 8-1 Reel Dimension



Туре	A(mm)	B(mm)	C(mm)	D(mm)
7"x8mm	8.4±1.0	50 min.	13±0.8	178±2

#### 8-2 Tape Dimension



2.0±0.1

1.40±0.1

4.0±0.1

2.5±0.1

#### 8-3 Packaging Quantity

201610

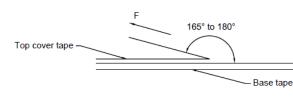
SPA

Chip size	201610	
Chip / Reel	2000	

NOTE: Specifications subject to change without notice. Please check our website for latest information.

0.23±0.05

#### 8-4 Tearing Off Force



The force for tearing off cover tape is 15 to 80 grams in the arrow direction under the following conditions

Room Temp. (℃)	Room Humidity (%)	Room atm (hPa)	Tearing Speed mm/min	
5~35	45~85	860~1060	300	

## Application Notice:

1. Storage Conditions:

To maintain the solderabililty of terminal electrodes:

- a) Recommended products should be used within 12 months from the time of delivery.
- b) The packaging material should be kept where no chlorine or sulfur exists in the air.
- 2. Transportation:
  - a) Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
  - b) Vacuum pick up is strongly recommended for individual components.
  - c) Bulk handling should ensure that abrasion and mechanical shock are minimized.